

# 3.3 V Triple LVPECL Input to -3.3 V to -5.0 V ECL Output Translator

# MC100LVEL91

## Description

The MC100LVEL91 is a triple LVPECL input to ECL output translator. The device receives low voltage differential PECL signals, determined by the  $V_{CC}$  supply level, and translates them to differential -3.3~V to -5.0~V ECL output signals.

To accomplish the level translation the LVEL91 requires three power rails. The  $V_{CC}$  supply should be connected to the positive supply, and the  $V_{EE}$  pin should be connected to the negative power supply. The GND pins are connected to the system ground plane. Both  $V_{EE}$  and  $V_{CC}$  should be bypassed to ground via 0.01  $\mu F$  capacitors.

Under open input conditions, the  $\overline{D}$  input will be biased at  $V_{CC}/2$  and the D input will be pulled to GND. This condition will force the Q output to a low, ensuring stability.

The  $V_{BB}$  pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  and  $V_{CC}$  via a 0.01  $\mu F$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  should be left open.

## **Features**

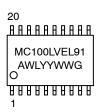
- 620 ps Typical Propagation Delay
- The 100 Series Contains Temperature Compensation
- Operating Range:  $V_{CC} = 3.8 \text{ V}$  to 3.0 V;  $V_{EE} = -3.0 \text{ V}$  to -5.5 V; GND = 0 V
- Q Output will Default LOW with Inputs Open or at GND
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

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#### **MARKING DIAGRAM\***

CASE 751D



A = Assembly Location
WL = Wafer Lot

YY = Year
WW = Work Week
G = Pb-Free Package

\*For additional marking information, refer to Application Note <u>AND8002/D</u>.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC100LVEL91DWG	SOIC-20 WB (Pb-Free)	38 Units/Tube

#### **DISCONTINUED** (Note 1)

MC100LVEL91DWR2G	SOIC-20 WB	1000/Tape &
	(Pb-Free)	Reel

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <a href="https://example.com/BRD8011/D">BRD8011/D</a>.
- DISCONTINUED: This device is not recommended for new design. Please contact your onsemi representative for information. The most current information on this device may be available on <a href="https://www.onsemi.com">www.onsemi.com</a>.

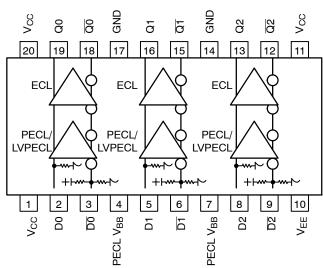


Figure 1. SO-20 Pinout (Top View) and Logic Diagram

\* All V<sub>CC</sub> pins are tied together on the die.

Warning: All  $V_{CC}$ ,  $V_{EE}$ , and GND pins must be externally connected to Power Supply to guarantee proper operation.

**Table 1. PIN DESCRIPTION** 

Pin	Function
Dn, <u>Dn</u> Qn, <del>Qn</del> PECL V <sub>BB</sub> V <sub>CC</sub> VEE GND	PECL/LVPECL Inputs ECL Outputs PECL Reference Voltage Output Positive Supply Negative Supply Ground

**Table 2. ATTRIBUTES** 

Characteristics	Value				
Internal Input Pulldown Resistor	75 kΩ				
Internal Input Pullup Resistor	75 kΩ				
ESD Protection Human Body Model Machine Model Charged Device Model	> 2 kV > 100 V > 2 kV				
Moisture Sensitivity, (Note 2): Pb-Free	Level 3				
Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in				
Transistor Count	282 Devices				
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test					

<sup>2.</sup> For additional information, see Application Note AND8003/D.

**Table 3. MAXIMUM RATINGS** 

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	PECL Power Supply	GND = 0 V		3.8	V
V <sub>EE</sub>	NECL Power Supply	GND = 0 V		-6.0	V
VI	PECL Input Voltage	GND = 0 V	V <sub>I</sub> ≤ V <sub>CC</sub>	3.8	V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA
I <sub>BB</sub>	PECL V <sub>BB</sub> Sink/Source			± 0.5	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
θЈА	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SOIC-20 WB	90 60	°C/W
θ <sub>JC</sub>	Thermal Resistance (Junction-to-Case)	Standard Board	SOIC-20 WB	30 to 35	°C/W
T <sub>sol</sub>	Wave Solder (Pb-Free)			265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 4. LVPECL INPUT DC CHARACTERISTICS ( $V_{CC} = 3.3 \text{ V}$ ;  $V_{EE} = -3.3 \text{ V}$  to -5.0 V; GND = 0 V (Note 3))

		-40°C		25°C		85°C					
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>CC</sub>	V <sub>CC</sub> Power Supply Current			11		6	11			11	mA
$V_{IH}$	Input HIGH Voltage (Single-Ended)	2135		2420	2135		2420	2135		2420	mV
$V_{IL}$	Input LOW Voltage (Single-Ended)	1490		1825	1490		1825	1490		1825	mV
LVPECL V <sub>BB</sub>	Output Voltage Reference	1.92		2.04	1.92		2.04	1.92		2.04	V
VIHCMR	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 4) V <sub>PP</sub> < 500 mV V <sub>PP</sub> ≥ 500 mV	1.0 1.2		2.9 2.9	0.9 1.1		2.9 2.9	0.9 1.1		2.9 2.9	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μΑ
I <sub>IL</sub>	Input LOW Current D D	0.5 -600			0.5 -600			0.5 -600			μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

Table 5. NECL OUTPUT DC CHARACTERISTICS ( $V_{CC} = 3.3 \text{ V}$ ;  $V_{EE} = -3.3 \text{ V}$  to -5.0 V; GND = 0 V (Note 5))

		−40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>EE</sub>	V <sub>EE</sub> Power Supply Current			27		21	27			29	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 6)	-1085	-1005	-880	-1025	-955	-880	-1025	-955	-880	mV
V <sub>OL</sub>	Output LOW Voltage (Note 6)	-1830	-1695	-1555	-1810	-1705	-1620	-1810	-1705	-1620	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

- 5. Output parameters vary 1:1 with GND.  $V_{CC}$  can vary +0.3 V / –0.5 V.
- 6. All loading with 50  $\Omega$  resistor to GND 2.0 V.

<sup>3.</sup> Input parameters vary 1:1 with V $_{CC}$ . V $_{CC}$  can vary +0.5 / -0.3 V. 4. V $_{IHCMR}$  min varies 1:1 with GND. V $_{IHCMR}$  max varies 1:1 with V $_{CC}$ .

Table 6. AC CHARACTERISTICS ( $V_{CC} = 3.3 \text{ V}$ ;  $V_{EE} = -3.0 \text{ V}$  to -5.5 V; GND = 0 V (Note 7))

		-40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Toggle Frequency		600			600			600		MHz
T <sub>PLH</sub>	Propagation Delay Differential Configuration D to Q Select-Ended	490 440	590 590	690 740	520 470	620 620	720 770	560 510	660 660	760 810	ps
t <sub>SKEW</sub>	Skew Output-to-Output (Note 8) Part-to-Part (Differential Configuration) (Note 8) Duty Cycle (Differential Configuration) (Note 9)		40 25	100 200		40 25	100 200		40 25	100 200	ps
$V_{PP}$	Input Swing (Note 10)	200		1000	200		1000	200		1000	mV
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times Q (20% – 80%)	320	400	580	320	400	580	320	400	580	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

- 7.  $V_{CC}$  can vary +0.5 V / -0.3 V.
- 8. Skews are valid across specified voltage range, part-to-part skew is for a given temperature.
- Duty cycle skew is the difference between a T<sub>PLH</sub> and T<sub>PHL</sub> propagation delay through a device.
   V<sub>PP</sub>(min) is the minimum input swing for which AC parameters are guaranteed. The device has a DC gain of ≈ 40.

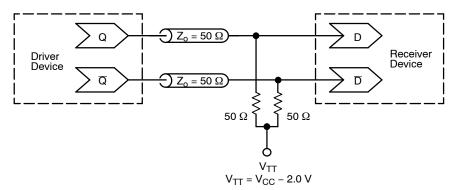


Figure 2. Typical Termination for Output Driver and Device Evaluation (See Application Note <u>AND8020/D</u> – Termination of ECL Logic Devices.)

# **Resource Reference of Application Notes**

AN1405/D	-	ECL Clock Distribution Techniques
AN1406/D	-	Designing with PECL (ECL at +5.0 V)
AN1503/D	-	ECLinPS™ I/O SPiCE Modeling Kit
AN1504/D	-	Metastability and the ECLinPS Family
AN1568/D	-	Interfacing Between LVDS and ECL
AN1672/D	_	The ECL Translator Guide
AND8001/D	_	Odd Number Counters Design
AND8002/D	_	Marking and Date Codes
AND8020/D	_	Termination of ECL Logic Devices
AND8066/D	_	Interfacing with ECLinPS
AND8090/D	-	AC Characteristics of ECL Devices

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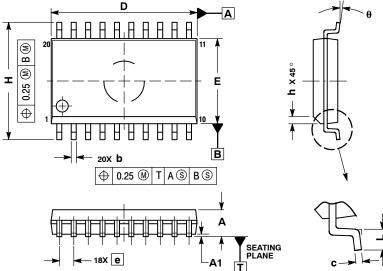




SOIC-20 WB CASE 751D-05 **ISSUE H** 

**DATE 22 APR 2015** 

# SCALE 1:1



- DIMENSIONS ARE IN MILLIMETERS.
   INTERPRET DIMENSIONS AND TOLERANCES.
- PER ASME Y14.5M, 1994.
  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD
- PROTRUSION.
  MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL

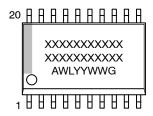
	MILLIMETERS							
DIM	MIN	MAX						
Α	2.35	2.65						
A1	0.10	0.25						
b	0.35	0.49						
С	0.23	0.32						
D	12.65	12.95						
E	7.40	7.60						
е	1.27	BSC						
Н	10.05	10.55						
h	0.25	0.75						
L	0.50	0.90						
A	0 °	7 °						

# **RECOMMENDED SOLDERING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

# **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code = Assembly Location

WL = Wafer Lot ΥY = Year WW = Work Week = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98ASB42343B	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED"		
DESCRIPTION:	SOIC-20 WB		PAGE 1 OF 1	

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